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MJD243T4G (NPN),
MJD253T4G (PNP)
Complementary Silicon Plastic Power Transistors

DPAK−3 for Surface Mount Applications

Designed for low voltage, low−power, high−gain audio amplifier applications.

Features

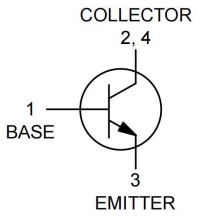
- High DC Current Gain
- Lead Formed for Surface Mount Applications in Plastic Sleeves (No Suffix)
- Straight Lead Version in Plastic Sleeves ("−1" Suffix)
- Low Collector−Emitter Saturation Voltage
- High Current−Gain − Bandwidth Product
- Annular Construction for Low Leakage
- Epoxy Meets UL 94 V−0 @ 0.125 in
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

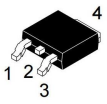
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector−Base Voltage	V_{CB}	100	Vdc
Collector−Emitter Voltage	V_{CEO}	100	Vdc
Emitter−Base Voltage	V_{EB}	7.0	Vdc
Collector Current − Continuous	I_C	4.0	Adc
Collector Current − Peak	I_{CM}	8.0	Adc
Base Current	I_B	1.0	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	12.5 0.1	W W/°C
Total Device Dissipation @ T_A = 25°C (Note 2) Derate above 25°C	P_D	1.4 0.011	W W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−65 to +150	°C
ESD − Human Body Model	HBM	3B	V
ESD − Machine Model	MM	C	V

4.0 A, 100 V, 12.5 W
POWER TRANSISTOR

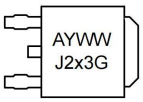
COMPLEMENTARY





DPAK−3
CASE 369C
STYLE 1

MARKING DIAGRAMS



DPAK

A = Assembly Location
Y = Year
WW = Work Week
x = 4 or 5
G = Pb−Free Package

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THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction−to−Case Junction−to−Ambient (Note 2)	 $R_{\theta JC}$ $R_{\theta JA}$	 10 89.3	°C/W

2. When surface mounted on minimum pad sizes recommended.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector−Emitter Sustaining Voltage (Note 3) (I_C = 10 mAdc, I_B = 0)	$V_{CEO(sus)}$	 100	 –	Vdc
Collector Cutoff Current (V_{CB} = 100 Vdc, I_E = 0) (V_{CB} = 100 Vdc, I_E = 0, T_J = 125°C)	I_{CBO}	 – –	 100 100	 nAdc μAdc
Emitter Cutoff Current (V_{BE} = 7.0 Vdc, I_C = 0)	I_{EBO}	 –	 100	nAdc
DC Current Gain (Note 3) (I_C = 200 mAdc, V_{CE} = 1.0 Vdc) (I_C = 1.0 Adc, V_{CE} = 1.0 Vdc)	h_{FE}	 40 15	 180 –	–
Collector−Emitter Saturation Voltage (Note 3) (I_C = 500 mAdc, I_B = 50 mAdc) (I_C = 1.0 Adc, I_B = 100 mAdc)	$V_{CE(sat)}$	 – –	 0.3 0.6	Vdc
Base−Emitter Saturation Voltage (Note 3) (I_C = 2.0 Adc, I_B = 200 mAdc)	$V_{BE(sat)}$	 –	 1.8	Vdc
Base−Emitter On Voltage (Note 3) (I_C = 500 mAdc, V_{CE} = 1.0 Vdc)	$V_{BE(on)}$	 –	 1.5	Vdc
DYNAMIC CHARACTERISTICS				
Current−Gain − Bandwidth Product (Note 4) (I_C = 100 mAdc, V_{CE} = 10 Vdc, f_{test} = 10 MHz)	f_T	 40	 –	MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 0.1 MHz)	C_{ob}	 –	 50	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≈ 2%.
4. $f_T = |h_{FE}| \bullet f_{test}$.

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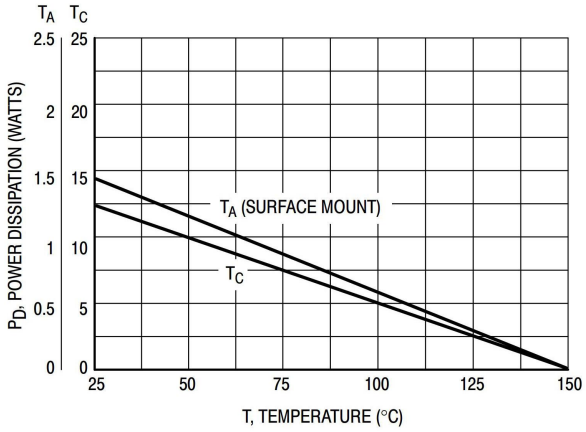

Figure 1. Power Derating

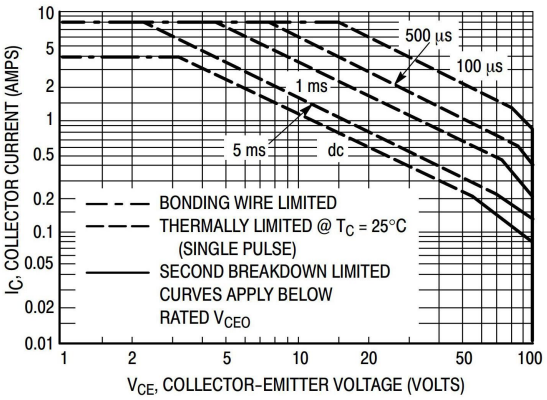

Figure 2. Active Region Maximum Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on $T_{J(pk)}$ = 150°C; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150°C$. $T_{J(pk)}$ may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

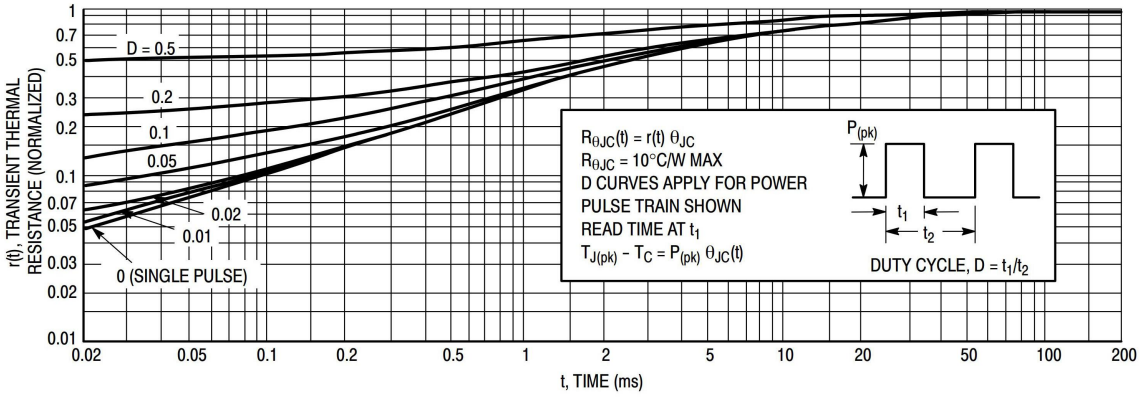

Figure 3. Thermal Response

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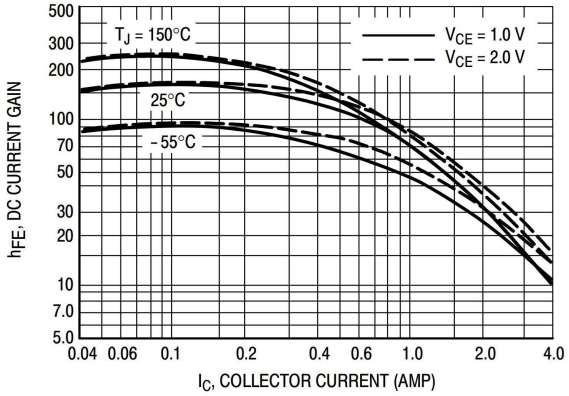
NPN
MJD243



PNP
MJD253

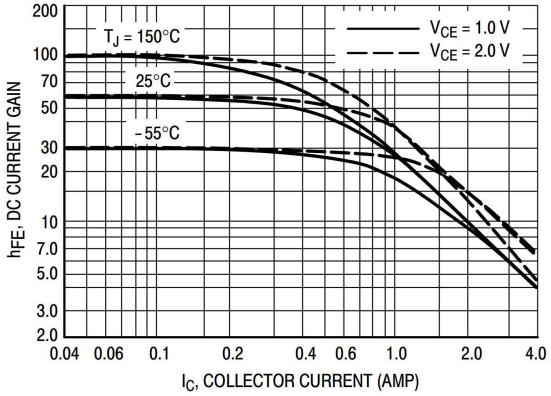
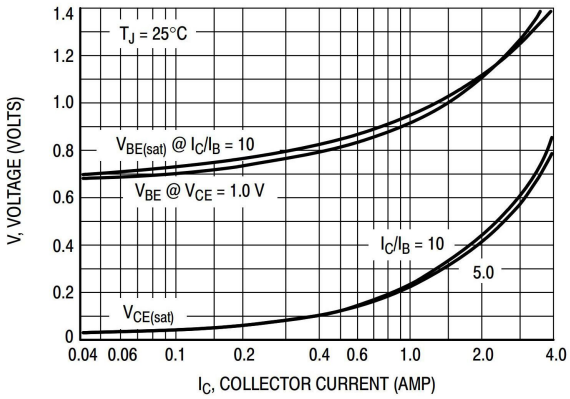


Figure 4. DC Current Gain



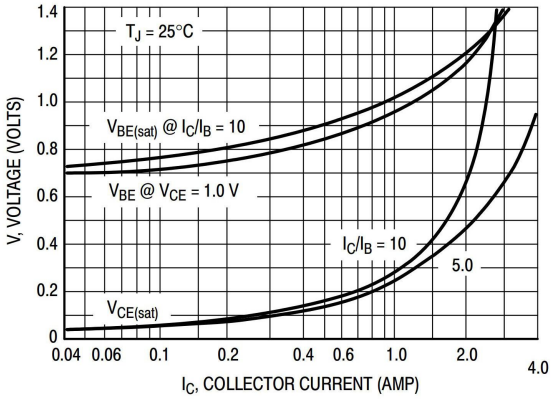
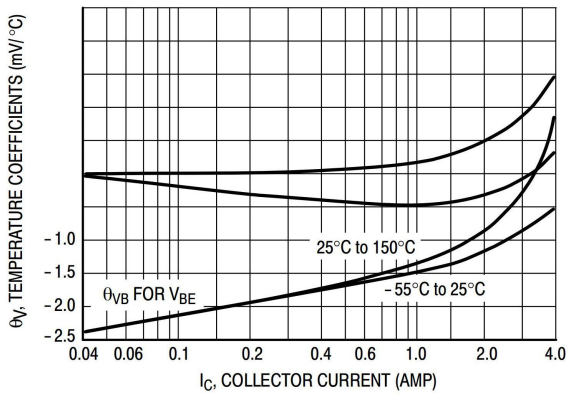


Figure 5. "On" Voltages



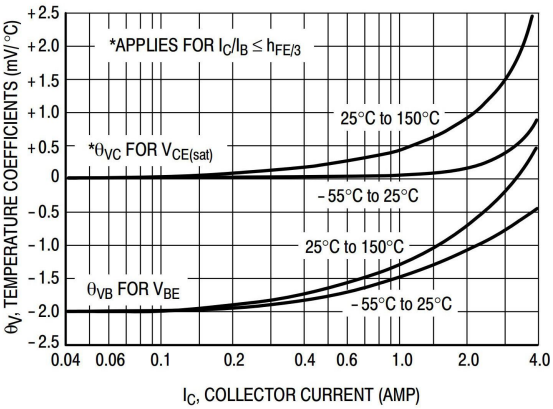


Figure 6. Temperature Coefficients

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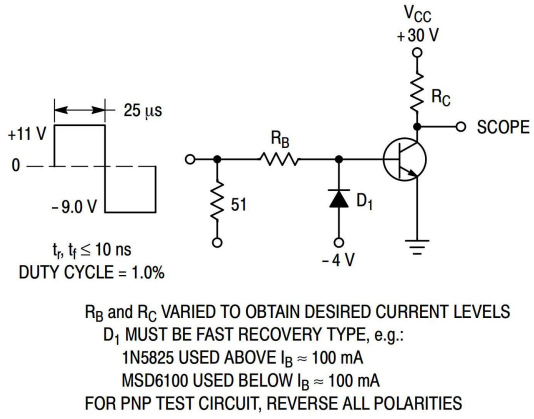

Figure 7. Switching Time Test Circuit

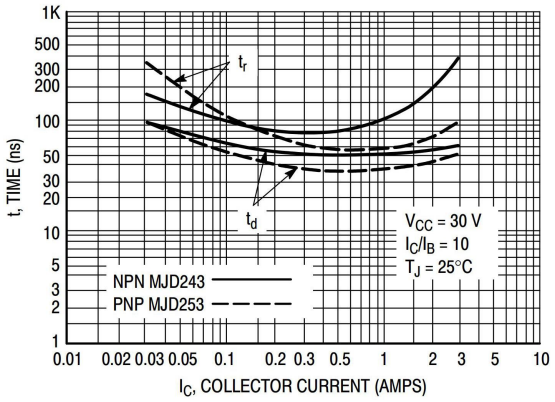

Figure 8. Turn−On Time

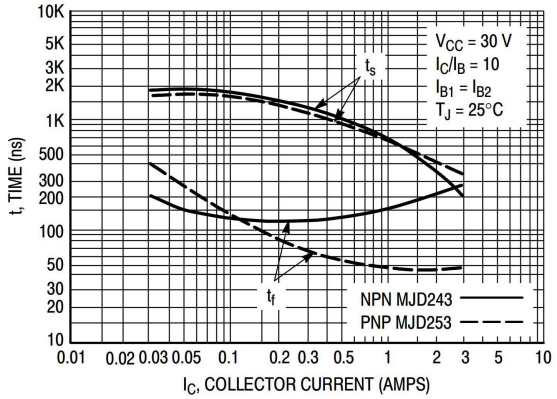

Figure 9. Turn−Off Time

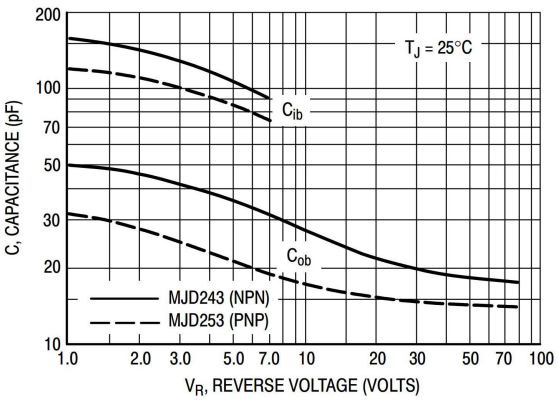

Figure 10. Capacitance

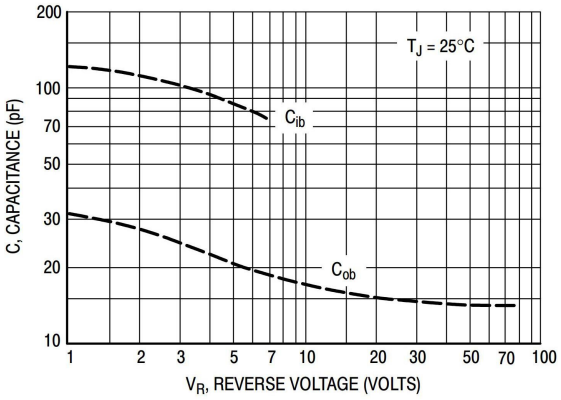

Figure 11. Capacitance

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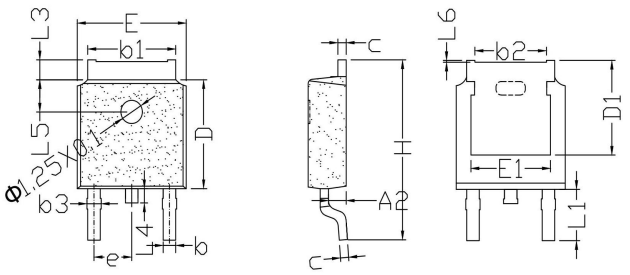
Ordering Information

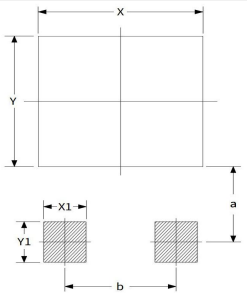
PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
TO-252	R3	0.305	2500	5000	25000	13''

Package Outline Dimensions (TO-252)



Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A2	0.90	1.10	0.035	0.043
b	0.66	0.86	0.026	0.034
b1	5.10	5.46	0.201	0.215
b2	4.27	4.37	0.168	0.172
b3	0.78	0.90	0.031	0.035
c	0.45	0.55	0.018	0.022
D	5.90	6.30	0.232	0.248
D1	5.35 REF.		0.211REF.	
E	6.30	6.70	0.248	0.264
E1	4.83 REF.		0.190 REF.	
e	2.18	2.38	0.086	0.094
H	9.80	10.4	0.386	0.409
L1	2.70	3.10	0.106	0.122
L3	0.80	1.20	0.031	0.047
L4	0.60	1.00	0.024	0.039
L5	1.8 REF.		0.071 REF.	
L6	-	0.12	-	0.005

Suggested Pad Layout



Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
a	3.70	-	0.146	-
b	4.37	-	0.172	-
X	-	5.80	-	0.228
X1	-	1.20	-	0.047
Y	-	5.85	-	0.230
Y1	-	2.00	-	0.079